October 19, 2026 01:16 AM GMT

Greater China Technology Hardware | Asia Pacific

2026 OCP Global Summit – MGX Upgrades Take Shape; Maia 300 on Display

At the rack level, Maia 300 is the key incremental story, while Nvidia/AMD exhibits offered limited new system-level hardware. Nvidia's MGX component upgrades are the main supply-chain watch points, although PTFE and next-gen interconnect and cooling connector (ZQD) adoption remains uncertain.

Nvidia/AMD – focus on ramps rather than new platforms. Most ODM displays were similar to Computex Taipei (early June), so timing of ramp is key. For Nvidia, VR200 racks have started a small-volume ramp, with the Nvidia Groq 3 LPX rack following in late 2026/early 2027 and standalone Vera CPU racks in late 1Q27/early 2Q27, based on our checks. For AMD, Helios remained largely unchanged with recent checks, with racks ramping in 1Q27, with pilot-build observations pointing to Shennan Circuits for EAM PCBs and Fositek/Parker for quick disconnects.

Maia 300 - a larger in-house inference opportunity. Microsoft plans production deployments in 2027 as it scales Maia toward multi-gigawatt deployments. Each rack integrates 96 accelerators within 167 kW. Based on that, each gigawatt of deployment would imply 5 to 5.5K racks, and we believe Hon Hai and Wiwynn could be the ODM partners, while our pilot-build observations point to ISU Petasys for the accelerator PCB, AVC for fans, and Fositek/Staubli for quick disconnects.

PTFE - technical upside, but no confirmed timing of adoption. Nvidia is evaluating PTFE for Rubin Ultra on Oberon following the Kyber delay and showcased its NVLink PTFE PCB with seven suppliers (though we think there are suppliers missing from this list). Better signal performance and reduced reliance on Q glass are potential benefits, but processing complexity, higher costs and yield/qualification risks remain hurdles to commercial adoption.

Ultra Dense Interconnect - next-generation interconnect opportunity for FIT. Nvidia showcased six suppliers for this next-generation interconnect, which is intended to replace Amphenol's current HD2 connector in midplane and cable cartridge applications. However, we believe adoption is still about two years away. In the meantime, the supply chain is working to improve yields and bring ASPs below US$100, with pogo-pin supply currently a bottleneck. Our checks identify FIT as the key design partner for Kyber's planned board-to-board connector, a position that bodes well for its supply share once the product ramps.

ZQD - higher flow density and an expected ASP premium. Nvidia's new ZQD targets higher flow rates per unit area and was displayed with 14 suppliers. Although the supply chain is working to improve yields and lower costs, greater design complexity should keep ASPs above current QD pricing of US$20–30.

MORGAN STANLEY TAIWAN LIMITED+

Howard Kao
Equity Analyst
Howard.Kao@morganstanley.com +886 2 2730-2989

Irene Yen
Equity Analyst
Irene.Yen@morganstanley.com +886 2 2730-2869

MORGAN STANLEY ASIA LIMITED+

Andy Meng, CFA
Equity Analyst
Andy.Meng@morganstanley.com +852 2239-7689

GREATER CHINA TECHNOLOGY HARDWARE
Asia Pacific
Industry View **In-Line**

Morgan Stanley does and seeks to do business with companies covered in Morgan Stanley Research. As a result, investors should be aware that the firm may have a conflict of interest that could affect the objectivity of Morgan Stanley Research. Investors should consider Morgan Stanley Research as only a single factor in making their investment decision.

For analyst certification and other important disclosures, refer to the Disclosure Section, located at the end of this report.

+= Analysts employed by non-U.S. affiliates are not registered with FINRA, may not be associated persons of the member and may not be subject to FINRA restrictions on communications with a subject company, public appearances and trading securities held by a research analyst account.

Major Takeaways from OCP Summit 2026

ODM/OEM: Almost all the ODM/OEMs had a booth at OCP, but during our visit, we feel most of the products were largely similar to what was showcased at Computex, such as the Vera Rubin NVL72 rack, the LPX tray, the Vera standalone tray. So net, we think from a hardware perspective, there was nothing new on Nvidia or AMD. We believe the Nvidia VR200 rack is already starting ramp in small volume, with the LPX rack starting to ramp later this year or early next year, and the Vera standalone CPU rack ramping late 1Q27 or early 2Q27.

AMD: Wiwynn, Meta, and AMD each showcased the Helios rack, which was unchanged from last year's OCP display with one exception: this year's version featured the actual compute tray in place of last year's dummy tray, allowing a closer look. That said, the compute tray itself was not new to us, as we had already seen it at OCP Taiwan in August.

- Based on our observations at the OCP Summit, we believe Shennan Circuits is one of the pilot build PCB suppliers for the MI455 Helios EAM PCB.
- Based on our observations at the OCP Summit, we believe Fositek (MQD02) and Parker (UQD04) are one of the pilot build quick disconnect connector suppliers for the MI455 Helios compute tray.
- HPE displayed the Helios switch tray at the OCP Summit. We believe the other supplier of the Helios switch trays is Celestica.

Microsoft: Maia 300 represents a major expansion of Microsoft's in-house inference infrastructure. Announced on October 12, 2026, with production deployments planned for 2027, it forms part of Microsoft's commitment to scale the Maia family to multi-gigawatt deployments and make it the primary inference platform for its products and services. The design targets long-context reasoning, conversational AI, and multi-step agentic workloads, with an emphasis on improving inference economics through coordinated silicon, software, and system design.

Maia 300 rack integrates 96 accelerators within a 167 kW power envelope, providing approximately 27.6 TB of aggregate HBM capacity. There are 4 accelerators per tray, implying 24 compute trays per rack, including six high-radix switch ASICs that are integrated into three liquid-cooled switch trays, providing the rack-local connectivity required by all 96 accelerators. Microsoft projects 40% more tokens per megawatt than leading GPU-based systems and up to 7× Maia 200's rack-level token throughput, though this takes into account that the Maia 300 rack includes twice as many accelerators per rack.

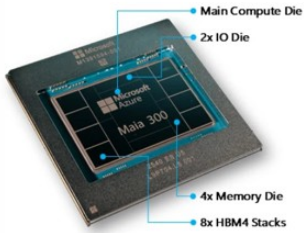
- The Official Microsoft Blog A two-tier Ethernet scale-up network connects up to 128 racks, or 12,288 accelerators, while liquid cooling removes more than 80% of rack heat. Each compute tray includes 8x fans (Exhibit 3), and based on our observations at the OCP Summit, we believe AVC is one of the pilot build fan suppliers for the sample compute tray.
- Based on our observations at the OCP Summit, we believe ISU Petasys is one of the pilot build PCB suppliers for Microsoft's Maia 300 AI accelerator.
- Based on our observations at the OCP Summit, we believe Fositek and Staubli are pilot build MQD03 (quick disconnect connector) suppliers for the compute tray.

- We believe Hon Hai and Wiwynn could be ODM partners for these racks.
- With each rack being 167 kW of power, one gigawatt of deployment would imply 5-5.5K racks, assuming a PUE of 1.1-1.2.

Exhibit 1: Maia 300 Specifications

Maia 300 Specifications

Peak specifications	Maia 200	Maia 300
Process technology	Monolithic N3P	Multi-chiplet N2P Compute
FP4 POPS	10.1	13.8
FP8 POPS	5.1	6.9
SoC TDP	750 W	950 W
HBM	6 x HBM3E stacks	8 x HBM4 stacks
HBM BW	7.1 TB/s	18 TB/s
HBM capacity	216 GB	288 GB
Back-end network	Two-tier Ethernet scale-up with AI Transport	Two-tier Ethernet scale-up with AI Transport
Scale-up BW: bi-directional	2.8 TB/s	3.2 TB/s
Pod Size	48 Maias/Rack	96 Maias/Rack
Cluster size (within scale-up domain)	~6k	~12k Maia accelerators



Source: Microsoft.

Exhibit 2: Maia 300 Rack Architecture

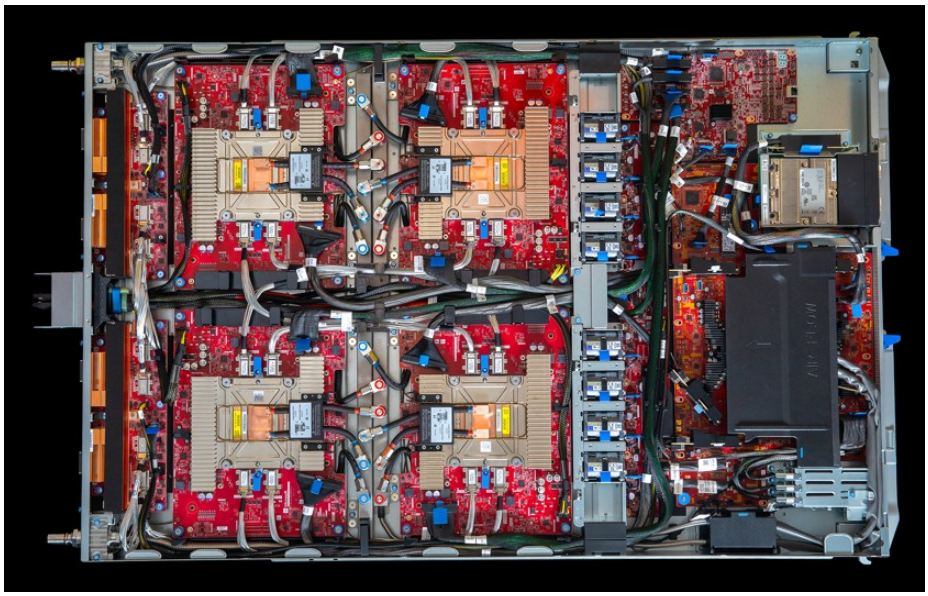
Maia 300 Rack Architecture

Rack specifications	Maia 200	Maia 300	Relative
Pod Size	48	96	2x
HBM BW	341 TB/s	1,728 TB/s	5.1x
HBM BW / W	5.3 GB/s	10.6 GB/s	1.95x
HBM capacity	10.4 TB	27.7 TB	2.7x
FP4 POPS	485	1,324	2.74x
Rack Power	64 kW	167 kW	2.6x



Source: Microsoft.

Exhibit 3: Maia 300 server compute tray



Source: Microsoft.

Nvidia MGX Ecosystem

PTFE: We previously wrote that our supply chain checks suggest that Nvidia had initially planned to adopt PTFE CCL for the very high-layer-count midplane in its Kyber architecture. With Kyber now delayed, and Rubin Ultra no longer expected to use that architecture, as previously discussed, the focus has shifted back to the Oberon architecture. Nvidia is again evaluating PTFE for Rubin Ultra on Oberon, and at this year's OCP Summit, Nvidia showcased its NVLink PTFE PCB, with a total of 7 suppliers, including VGT, TTM, Taiflex, SYTECH, Shennan Circuits, Kinwong, and Flexium (Exhibit 4 & Exhibit 5). However, our checks indicate that actual adoption for Rubin Ultra remains uncertain.

However, we find the supplier list puzzling. Our checks suggest that WUS PCB and Unimicron are also working on this solution, and that Flexium, which has collaborated with other PCB suppliers, may handle only a few process steps. Our checks also indicate that Shennan Circuits, WUS PCB and VGT are now the leading PCB makers for this solution, with relatively higher yields.

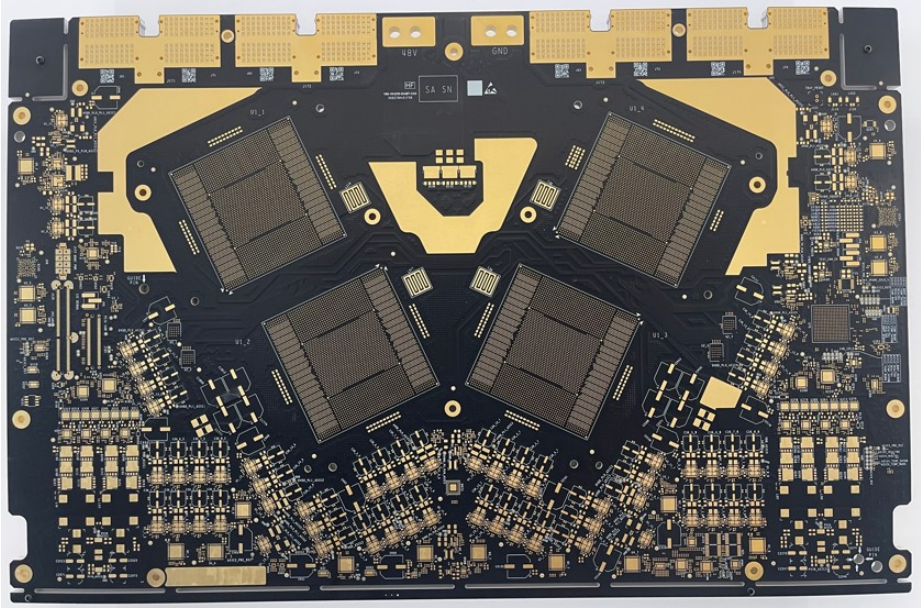
Advantages of PTFE

- **Best signal performance:** the lowest Dk and Df of the mainstream options, below even standard M9-class CCLs. This matters most where insertion-loss budgets are tightest, i.e. the highest speeds and highest layer counts.
- **Stable electricals:** the low Dk/Df hold up across frequency and temperature, and PTFE absorbs very little moisture, so performance is stable in use.
- **Less dependence on Q glass:** because PTFE's intrinsic dielectric constant is already very low, reaching the target Dk requires less (and in some hybrid constructions, none) of the expensive, supply-constrained Q glass. That is both a cost lever and a supply-security benefit.

Disadvantages of PTFE

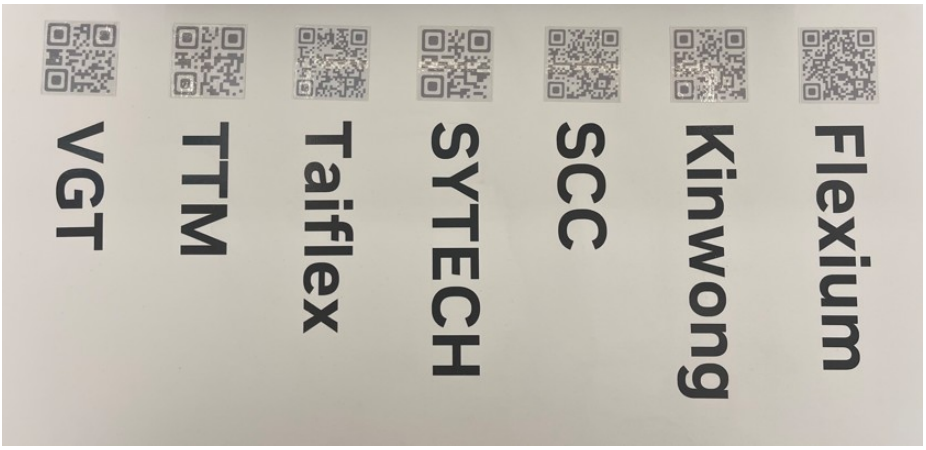
- **Mechanically soft:** low modulus makes it difficult to handle and to hold to tolerance.
- **Difficult lamination:** PTFE does not flow like a thermoset, so bonding needs either very high temperatures or lower-melting fluoropolymer (such as PFA (polyfluoroalkoxy))/thermoset bond layers; its high, non-linear CTE stresses copper adhesion and complicates layer-to-layer registration, and pressing typically requires vacuum or an inert atmosphere with longer cycles.
- **Difficult drilling:** the soft, gummy resin tends to smear and can tear, and any ceramic filler is abrasive on tooling. Also, the hole wall will not accept electroless copper without an added activation step (sodium etch or plasma) on top of normal desmear.
- **Higher cost and qualification risk:** materials and fabrication are both more expensive, the qualified supply base is narrower, and yields at very high layer counts carry risk.

Exhibit 4: Nvidia's NVLink PTFE Board



Source: Nvidia, Morgan Stanley Research.

Exhibit 5: Nvidia PTFE PCB Supplier List



Source: Nvidia, Morgan Stanley Research.

Ultra Dense Interconnect: Currently, Nvidia's NVL72 racks are using Amphenol's Paladin HD2 connectors for VR200 NVL72 midplanes and cable cartridges. Our previous checks done around Computex 2026 in June, indicate ASP could reach US$70-90+ per set. For the next-generation Kyber racks, our checks have previously indicated that a new midplane connector called "Voronoi" will be introduced, and FIT is the key design partner for this new board-to-board connector. At this year's OCP Summit, Nvidia showcased a new connector it calls the "Ultra Dense Interconnect", with six suppliers in total. This was our first in-person look at the design. We believe adoption is still two years out, and the supply chain is currently focused on improving yields and optimizing costs to bring the ASP below US$100. Our checks suggest that pogo pin supply is currently a bottleneck for this connector.

Exhibit 6: Nvidia next-generation Ultra Dense Interconnect



Source: Nvidia, Morgan Stanley Research.

ZQD: At COMPUTEX in Taipei earlier this year, we noted that our checks indicated Nvidia was planning to introduce a new quick disconnect (QD) design for next-generation server racks to achieve higher flow rates per unit area as cooling requirements rise. At this year's OCP Summit, Nvidia showcased that design, called ZQD, with 14 suppliers in total. Our checks indicate the supply chain is also working to improve yields and optimize costs to bring ZQD ASPs down. However, given the greater complexity of the design, we expect ZQD ASPs to remain above current QD pricing of US$20–30 per set.

Exhibit 7: Nvidia's new ZQD liquid cooling quick disconnect connectors



Source: Nvidia, Morgan Stanley Research.

Disclosure Section

The information and opinions in Morgan Stanley Research were prepared or are disseminated by Morgan Stanley Asia Limited (which accepts the responsibility for its contents) and/or Morgan Stanley Asia (Singapore) Pte. (Registration number 199206298Z) and/or Morgan Stanley Asia (Singapore) Securities Pte Ltd (Registration number 200008434H), regulated by the Monetary Authority of Singapore (which accepts legal responsibility for its contents and should be contacted with respect to any matters arising from, or in connection with, Morgan Stanley Research), and/or Morgan Stanley Taiwan Limited and/or Morgan Stanley & Co International plc, Seoul Branch, and/or Morgan Stanley Australia Limited (A.B.N. 67 003 734 576, holder of Australian financial services license No. 233742, which accepts responsibility for its contents), and/or Morgan Stanley Wealth Management Australia Pty Ltd (A.B.N. 19 009 145 555, holder of Australian financial services license No. 240813, which accepts responsibility for its contents), and/or Morgan Stanley India Company Private Limited having Corporate Identification No (CIN) U22990MH1998PTC115305, regulated by the Securities and Exchange Board of India ("SEBI") and holder of licenses as a Research Analyst (SEBI Registration No. INH000001105); Stock Broker (SEBI Stock Broker Registration No. INZ000244438), Merchant Banker (SEBI Registration No. INM000011203), and depository participant with National Securities Depository Limited (SEBI Registration No. IN-DP-NSDL-567-2021) having registered office at Altimus, Level 39 & 40, Pandurang Budhkar Marg, Worli, Mumbai 400018, India; Telephone no. +91-22-61181000; Compliance Officer Details: Mr. Tejarshi Hardas, Tel. No.: +91-22-61181000 or Email: tejarshi.hardas@morganstanley.com; Grievance officer details: Mr. Tejarshi Hardas, Tel. No.: +91-22-61181000 or Email: msic-compliance@morganstanley.com which accepts the responsibility for its contents and should be contacted with respect to any matters arising from, or in connection with, Morgan Stanley Research, and their affiliates (collectively, "Morgan Stanley"). Morgan Stanley India Company Private Limited (MSICPL) may use AI tools in providing research services. All recommendations contained herein are made by the duly qualified research analysts.

For important disclosures, stock price charts and equity rating histories regarding companies that are the subject of this report, please see the Morgan Stanley Research Disclosure Website at www.morganstanley.com/eqr/disclosures/webapp/generalresearch, or contact your investment representative or Morgan Stanley Research at 1585 Broadway, (Attention: Research Management), New York, NY, 10036 USA.

For valuation methodology and risks associated with any recommendation, rating or price target referenced in this research report, please contact the Client Support Team as follows: US/Canada +1 800 303-2495; Hong Kong +852 2848-5999; Latin America +1 718 754-5444 (U.S.); London +44 (0)20-7425-8169; Singapore +65 6834-6860; Sydney +61 (0)2-9770-1505; Tokyo +81 (0)3-6836-9000. Alternatively you may contact your investment representative or Morgan Stanley Research at 1585 Broadway, (Attention: Research Management), New York, NY 10036 USA.

Analyst Certification

The following analysts hereby certify that their views about the companies and their securities discussed in this report are accurately expressed and that they have not received and will not receive direct or indirect compensation in exchange for expressing specific recommendations or views in this report: Howard Kao; Andy Meng, CFA; Irene Yen.

.

Global Research Conflict Management Policy

Morgan Stanley Research has been published in accordance with our conflict management policy, which is available at www.morganstanley.com/institutional/research/conflictpolicies. A Portuguese version of the policy can be found at www.morganstanley.com.br

Important Regulatory Disclosures on Subject Companies

As of September 30, 2026, Morgan Stanley beneficially owned 1% or more of a class of common equity securities of the following companies covered in Morgan Stanley Research: AAC Technologies Holdings, Accton Technology Corporation, Acer Inc., AirTAC International, Asustek Computer Inc., AU Optronics, Auras Technology Co Ltd, Bizlink, Catcher Technology, Chenbro, Co-Tech Development Corp., Compal Electronics, Delta Electronics Inc., E Ink Holdings Inc., Elite Material Co., Ennostar Inc, Eoptolink Technology Inc Ltd, Fositek Corp, Genius Electronic Optical Co. Ltd., Giga-Byte Technology Co. Ltd., Hiwin Technologies Corp., LandMark Optoelectronics Corporation, Largan Precision, Lens Technology, Lingyi Itech Guangdong Co, Lite-On Technology, Lotes Co. Ltd., Nan Ya PCB, Quectel Wireless Solutions Co Ltd, Sunny Optical, Suzhou TFC Optical Communication Co Ltd., Taiwan Union Technology Corporation, Unimicron, Visual Photonics Epitaxy Co Ltd, Wistron Corporation, Wiwynn Corp, Xiaomi Corp, Yageo Corp., Yangtze Optical Fibre and Cable JSC Ltd, Zhejiang Crystal-Optech Co Ltd, Zhen Ding, Zhongji Innolight Co Ltd, ZTE Corporation.

Within the last 12 months, Morgan Stanley managed or co-managed a public offering (or 144A offering) of securities of Asustek Computer Inc., Unimicron, Wistron Corporation, Wiwynn Corp, Zhen Ding, Zhongji Innolight Co Ltd.

Within the last 12 months, Morgan Stanley has received compensation for investment banking services from Asustek Computer Inc., Lenovo, Unimicron, Wistron Corporation, Wiwynn Corp, Xiaomi Corp, Yageo Corp., Zhen Ding, Zhongji Innolight Co Ltd.

In the next 3 months, Morgan Stanley expects to receive or intends to seek compensation for investment banking services from AAC Technologies Holdings, Accton Technology Corporation, Acer Inc., Advantech, AirTAC International, Asustek Computer Inc., AU Optronics, Bizlink, Catcher Technology, Chenbro, Compal Electronics, Delta Electronics Inc., E Ink Holdings Inc., Elite Material Co., Ennostar Inc, Eoptolink Technology Inc Ltd, FIT Hon Teng Ltd, Giga-Byte Technology Co. Ltd., Gold Circuit Electronics Ltd., Hon Hai Precision, Innolux, Lenovo, Lens Technology, Lingyi Itech Guangdong Co, Lite-On Technology, Lotes Co. Ltd., Luxshare Precision Industry Co., Ltd., Pegatron Corporation, Q Technology (Group) Company Ltd, Quanta Computer Inc., Shanghai Conant Optical Co Ltd, Shenzhen Transsion Holdings Co Ltd, Suzhou TFC Optical Communication Co Ltd., TCL Corp., Unimicron, Wistron Corporation, Wiwynn Corp, Xiaomi Corp, Yageo Corp., Yangtze Optical Fibre and Cable JSC Ltd, Zhen Ding, Zhongji Innolight Co Ltd.

Within the last 12 months, Morgan Stanley has received compensation for products and services other than investment banking services from AAC Technologies Holdings, Accton Technology Corporation, Acer Inc., Asustek Computer Inc., AU Optronics, BYD Electronics, Compal Electronics, E Ink Holdings Inc., Eoptolink Technology Inc Ltd, Giga-Byte Technology Co. Ltd., GoerTek Inc, Hon Hai Precision, Innolux, Lenovo, Lingyi Itech Guangdong Co, Quanta Computer Inc., Xiaomi Corp, Yageo Corp..

Within the last 12 months, Morgan Stanley has provided or is providing investment banking services to, or has an investment banking client relationship with, the following company: AAC Technologies Holdings, Accton Technology Corporation, Acer Inc., Advantech, AirTAC International, Asustek Computer Inc., AU Optronics, Bizlink, Catcher Technology, Chenbro, Compal Electronics, Delta Electronics Inc., E Ink Holdings Inc., Elite Material Co., Ennostar Inc, Eoptolink Technology Inc Ltd, FIT Hon Teng Ltd, Giga-Byte Technology Co. Ltd., Gold Circuit Electronics Ltd., Hon Hai Precision, Innolux, Lenovo, Lens Technology, Lingyi Itech Guangdong Co, Lite-On Technology, Lotes Co. Ltd., Luxshare Precision Industry Co., Ltd., Pegatron Corporation, Q Technology (Group) Company Ltd, Quanta Computer Inc., Shanghai Conant Optical Co Ltd, Shenzhen Transsion Holdings Co Ltd, Suzhou TFC Optical Communication Co Ltd., TCL Corp., Unimicron, Wistron Corporation, Wiwynn Corp, Xiaomi Corp, Yageo Corp., Yangtze Optical Fibre and Cable JSC Ltd, Zhen Ding, Zhongji Innolight Co Ltd.

Within the last 12 months, Morgan Stanley has either provided or is providing non-investment banking, securities-related services to and/or in the past has entered into an agreement to provide services or has a client relationship with the following company: AAC Technologies Holdings, Accton Technology Corporation, Acer Inc., Asustek Computer Inc., AU Optronics, BYD Electronics, Compal Electronics, E Ink Holdings Inc., Eoptolink Technology Inc Ltd, Giga-Byte Technology Co. Ltd., GoerTek Inc, Hon Hai Precision, Innolux, Lenovo, Lingyi Itech Guangdong Co, Quanta Computer Inc., Xiaomi Corp, Yageo Corp., Zhen Ding.

The equity research analysts or strategists principally responsible for the preparation of Morgan Stanley Research have received compensation based upon various factors, including quality

of research, investor client feedback, stock picking, competitive factors, firm revenues and overall investment banking revenues. Equity Research analysts' or strategists' compensation is not linked to investment banking or capital markets transactions performed by Morgan Stanley or the profitability or revenues of particular trading desks.
Morgan Stanley and its affiliates do business that relates to companies/instruments covered in Morgan Stanley Research, including market making, providing liquidity, fund management, commercial banking, extension of credit, investment services and investment banking. Morgan Stanley sells to and buys from customers the securities/instruments of companies covered in Morgan Stanley Research on a principal basis. Morgan Stanley may have a position in the debt of the Company or instruments discussed in this report. Morgan Stanley trades or may trade as principal in the debt securities (or in related derivatives) that are the subject of the debt research report.
Certain disclosures listed above are also for compliance with applicable regulations in non-US jurisdictions.

STOCK RATINGS

Morgan Stanley uses a relative rating system using terms such as Overweight, Equal-weight, Not-Rated or Underweight (see definitions below). Morgan Stanley does not assign ratings of Buy, Hold or Sell to the stocks we cover. Overweight, Equal-weight, Not-Rated and Underweight are not the equivalent of buy, hold and sell. Investors should carefully read the definitions of all ratings used in Morgan Stanley Research. In addition, since Morgan Stanley Research contains more complete information concerning the analyst's views, investors should carefully read Morgan Stanley Research, in its entirety, and not infer the contents from the rating alone. In any case, ratings (or research) should not be used or relied upon as investment advice. An investor's decision to buy or sell a stock should depend on individual circumstances (such as the investor's existing holdings) and other considerations.

Global Stock Ratings Distribution

(as of September 30, 2026)
The Stock Ratings described below apply to Morgan Stanley's Fundamental Equity Research and do not apply to Debt Research produced by the Firm.
For disclosure purposes only (in accordance with FINRA requirements), we include the category headings of Buy, Hold, and Sell alongside our ratings of Overweight, Equal-weight, Not-Rated and Underweight. Morgan Stanley does not assign ratings of Buy, Hold or Sell to the stocks we cover. Overweight, Equal-weight, Not-Rated and Underweight are not the equivalent of buy, hold, and sell but represent recommended relative weightings (see definitions below). To satisfy regulatory requirements, we correspond Overweight, our most positive stock rating, with a buy recommendation; we correspond Equal-weight and Not-Rated to hold and Underweight to sell recommendations, respectively.

	Coverage Universe		Investment Banking Clients (IBC)			Other Material Investment Services Clients (MISC)	
Stock Rating Category	Count	% of Total	Count	% of Total IBC	% of Rating Category	Count	% of Total Other MISC
Overweight/Buy	1599	43%	455	48%	28%	783	44%
Equal-weight/Hold	1563	42%	394	42%	25%	763	43%
Not-Rated/Hold	2	0%	1	0%	50%	1	0%
Underweight/Sell	570	15%	96	10%	17%	227	13%
Total	3,734		946			1774	

Data include common stock and ADRs currently assigned ratings. Investment Banking Clients are companies from whom Morgan Stanley received investment banking compensation in the last 12 months. Due to rounding off of decimals, the percentages provided in the "% of total" column may not add up to exactly 100 percent.

Analyst Stock Ratings

Overweight (O). The stock's total return is expected to exceed the average total return of the analyst's industry (or industry team's) coverage universe, on a risk-adjusted basis, over the next 12-18 months.
Equal-weight (E). The stock's total return is expected to be in line with the average total return of the analyst's industry (or industry team's) coverage universe, on a risk-adjusted basis, over the next 12-18 months.
Not-Rated (NR). Currently the analyst does not have adequate conviction about the stock's total return relative to the average total return of the analyst's industry (or industry team's) coverage universe, on a risk-adjusted basis, over the next 12-18 months.
Underweight (U). The stock's total return is expected to be below the average total return of the analyst's industry (or industry team's) coverage universe, on a risk-adjusted basis, over the next 12-18 months.
Unless otherwise specified, the time frame for price targets included in Morgan Stanley Research is 12 to 18 months.

Analyst Industry Views

Attractive (A): The analyst expects the performance of his or her industry coverage universe over the next 12-18 months to be attractive vs. the relevant broad market benchmark, as indicated below.
In-Line (I): The analyst expects the performance of his or her industry coverage universe over the next 12-18 months to be in line with the relevant broad market benchmark, as indicated below.
Cautious (C): The analyst views the performance of his or her industry coverage universe over the next 12-18 months with caution vs. the relevant broad market benchmark, as indicated below.
Benchmarks for each region are as follows: North America - S&P 500; Latin America - relevant MSCI country index or MSCI Latin America Index; Europe - MSCI Europe; Japan - TOPIX; Asia - relevant MSCI country index or MSCI sub-regional index or MSCI AC Asia Pacific ex Japan Index.

Important Disclosures for Morgan Stanley Smith Barney LLC Customers

Important disclosures regarding any material conflict of interest that can reasonably be expected to have influenced Morgan Stanley Smith Barney LLC's choice of a third-party research provider or the subject company of a third-party research report, are available on the Morgan Stanley Wealth Management disclosure website at www.morganstanley.com/online/researchdisclosures.
For Morgan Stanley specific disclosures, you may refer to https://www.morganstanley.com/eqr/disclosures/webapp/generalresearch.
Each Morgan Stanley research report is reviewed and approved on behalf of Morgan Stanley Smith Barney LLC. This review and approval is conducted by the same person who reviews the research report on behalf of Morgan Stanley. This could create a conflict of interest.

Other Important Disclosures

Morgan Stanley Research policy is to update research reports as and when the Research Analyst and Research Management deem appropriate, based on developments with the issuer, the sector, or the market that may have a material impact on the research views or opinions stated therein. In addition, certain Research publications are intended to be updated on a regular periodic basis (weekly/monthly/quarterly/annual) and will ordinarily be updated with that frequency, unless the Research Analyst and Research Management determine that a different publication schedule is appropriate based on current conditions.

Morgan Stanley is not acting as a municipal advisor and the opinions or views contained herein are not intended to be, and do not constitute, advice within the meaning of Section 975 of the Dodd-Frank Wall Street Reform and Consumer Protection Act.

Morgan Stanley produces an equity research product called a "Tactical Idea." Views contained in a "Tactical Idea" on a particular stock may be contrary to the recommendations or views expressed in research on the same stock. This may be the result of differing time horizons, methodologies, market events, or other factors. For all research available on a particular stock, please contact your sales representative or go to Matrix at http://www.morganstanley.com/matrix.

Morgan Stanley Research is provided to our clients through our proprietary research portal on Matrix and also distributed electronically by Morgan Stanley to clients. Certain, but not all, Morgan Stanley Research products are also made available to clients through third-party vendors or redistributed to clients through alternate electronic means as a convenience. For access to all available Morgan Stanley Research, please contact your sales representative or go to Matrix at http://www.morganstanley.com/matrix.

Any access and/or use of Morgan Stanley Research is subject to Morgan Stanley's Terms of Use (http://www.morganstanley.com/terms.html). By accessing and/or using Morgan Stanley Research, you are indicating that you have read and agree to be bound by our Terms of Use (http://www.morganstanley.com/terms.html). In addition you consent to Morgan Stanley processing your personal data and using cookies in accordance with our Privacy Policy and our Global Cookies Policy (http://www.morganstanley.com/privacy_pledge.html), including for the purposes of setting your preferences and to collect readership data so that we can deliver better and more personalized service and products to you. To find out more information about how Morgan Stanley processes personal data, how we use cookies and how to reject cookies see our Privacy Policy and our Global Cookies Policy (http://www.morganstanley.com/privacy_pledge.html). Please use the provided link to review the Terms and Conditions and Most Important Terms and Conditions for Morgan Stanley India Company Private Limited (https://www.morganstanley.com/assets/pdfs/about-us-global-offices/india/Terms_and_conditions.pdf) and the following link to review the audit report (https://ny.matrix.ms.com/eqr/research/webapp/researchdocs/MSICPL_Morgan_Stanley_Research_Audit_Report.pdf).

If you do not agree to our Terms of Use and/or if you do not wish to provide your consent to Morgan Stanley processing your personal data or using cookies please do not access our research.

Morgan Stanley Research does not provide individually tailored investment advice. Morgan Stanley Research has been prepared without regard to the circumstances and objectives of those who receive it. Morgan Stanley recommends that investors independently evaluate particular investments and strategies, and encourages investors to seek the advice of a financial adviser. The appropriateness of an investment or strategy will depend on an investor's circumstances and objectives. The securities, instruments, or strategies discussed in Morgan Stanley Research may not be suitable for all investors, and certain investors may not be eligible to purchase or participate in some or all of them. Morgan Stanley Research is not an offer to buy or sell or the solicitation of an offer to buy or sell any security/instrument or to participate in any particular trading strategy. The value of and income from your investments may vary because of changes in interest rates, foreign exchange rates, default rates, prepayment rates, securities/instruments prices, market indexes, operational or financial conditions of companies or other factors. There may be time limitations on the exercise of options or other rights in securities/instruments transactions. Past performance is not necessarily a guide to future performance. Estimates of future performance are based on assumptions that may not be realized. If provided, and unless otherwise stated, the closing price on the cover page is that of the primary exchange for the subject company's securities/instruments.

The fixed income research analysts, strategists or economists principally responsible for the preparation of Morgan Stanley Research have received compensation based upon various factors, including quality, accuracy and value of research, firm profitability or revenues (which include fixed income trading and capital markets profitability or revenues), client feedback and competitive factors. Fixed Income Research analysts', strategists' or economists' compensation is not linked to investment banking or capital markets transactions performed by Morgan Stanley or the profitability or revenues of particular trading desks.

The "Important Regulatory Disclosures on Subject Companies" section in Morgan Stanley Research lists all companies mentioned where Morgan Stanley owns 1% or more of a class of common equity securities of the companies. For all other companies mentioned in Morgan Stanley Research, Morgan Stanley may have an investment of less than 1% in securities/instruments or derivatives of securities/instruments of companies and may trade them in ways different from those discussed in Morgan Stanley Research. Employees of Morgan Stanley not involved in the preparation of Morgan Stanley Research may have investments in securities/instruments or derivatives of securities/instruments of companies mentioned and may trade them in ways different from those discussed in Morgan Stanley Research. Derivatives may be issued by Morgan Stanley or associated persons.

With the exception of information regarding Morgan Stanley, Morgan Stanley Research is based on public information. Morgan Stanley makes every effort to use reliable, comprehensive information, but we make no representation that it is accurate or complete. We have no obligation to tell you when opinions or information in Morgan Stanley Research change apart from when we intend to discontinue equity research coverage of a subject company. Facts and views presented in Morgan Stanley Research have not been reviewed by, and may not reflect information known to, professionals in other Morgan Stanley business areas, including investment banking personnel.

Morgan Stanley Research personnel may participate in company events such as site visits and are generally prohibited from accepting payment by the company of associated expenses unless pre-approved by authorized members of Research management.

Morgan Stanley may make investment decisions that are inconsistent with the recommendations or views in this report.

To our readers based in Taiwan or trading in Taiwan securities/instruments: Information on securities/instruments that trade in Taiwan is distributed by Morgan Stanley Taiwan Limited ("MSTL"). Such information is for your reference only. The reader should independently evaluate the investment risks and is solely responsible for their investment decisions. Morgan Stanley Research may not be distributed to the public media or quoted or used by the public media without the express written consent of Morgan Stanley. Any non-customer reader within the scope of Article 7-1 of the Taiwan Stock Exchange Recommendation Regulations accessing and/or receiving Morgan Stanley Research is not permitted to provide Morgan Stanley Research to any third party (including but not limited to related parties, affiliated companies and any other third parties) or engage in any activities regarding Morgan Stanley Research which may create or give the appearance of creating a conflict of interest. Information on securities/instruments that do not trade in Taiwan is for informational purposes only and is not to be construed as a recommendation or a solicitation to trade in such securities/instruments. MSTL may not execute transactions for clients in these securities/instruments.

Certain information in Morgan Stanley Research was sourced by employees of the Shanghai Representative Office of Morgan Stanley Asia Limited for the use of Morgan Stanley Asia Limited. Morgan Stanley is not incorporated under PRC law and the research in relation to this report is conducted outside the PRC. Morgan Stanley Research does not constitute an offer to sell or the solicitation of an offer to buy any securities in the PRC. PRC investors shall have the relevant qualifications to invest in such securities and shall be responsible for obtaining all relevant approvals, licenses, verifications and/or registrations from the relevant governmental authorities themselves. Neither this report nor any part of it is intended as, or shall constitute, provision of any consultancy or advisory service of securities investment as defined under PRC law. Such information is provided for your reference only.

Morgan Stanley Research is disseminated in Brazil by Morgan Stanley C.T.V.M. S.A. located at Av. Brigadeiro Faria Lima, 3600, 6th floor, São Paulo - SP, Brazil; and is regulated by the Comissão de Valores Mobiliários; in Mexico by Morgan Stanley México, Casa de Bolsa, S.A. de C.V which is regulated by Comision Nacional Bancaria y de Valores. Paseo de los Tamarindos 90, Torre 1,

Col. Bosques de las Lomas Floor 29, 05120 Mexico City; in Japan by Morgan Stanley MUFG Securities Co., Ltd. and, for Commodities related research reports only, Morgan Stanley Capital Group Japan Co., Ltd; in Hong Kong by Morgan Stanley Asia Limited (which accepts responsibility for its contents) and by Morgan Stanley Bank Asia Limited; in Singapore by Morgan Stanley Asia (Singapore) Pte. (Registration number 199206298Z) and/or Morgan Stanley Asia (Singapore) Securities Pte Ltd (Registration number 200008434H), regulated by the Monetary Authority of Singapore (which accepts legal responsibility for its contents and should be contacted with respect to any matters arising from, or in connection with, Morgan Stanley Research) and by Morgan Stanley Bank Asia Limited, Singapore Branch (Registration number T14FC0118J); in Australia to "wholesale clients" within the meaning of the Australian Corporations Act by Morgan Stanley Australia Limited A.B.N. 67 003 734 576, holder of Australian financial services license No. 233742, which accepts responsibility for its contents; in Australia to "wholesale clients" and "retail clients" within the meaning of the Australian Corporations Act by Morgan Stanley Wealth Management Australia Pty Ltd (A.B.N. 19 009 145 555, holder of Australian financial services license No. 240813, which accepts responsibility for its contents; in Korea by Morgan Stanley & Co International plc, Seoul Branch; in India by Morgan Stanley India Company Private Limited having Corporate Identification No (CIN) U22990MH1998PTC115305, regulated by the Securities and Exchange Board of India ("SEBI") and holder of licenses as a Research Analyst (SEBI Registration No. INH000001105); Stock Broker (SEBI Stock Broker Registration No. INZ000244438), Merchant Banker (SEBI Registration No. INM000011203), and depository participant with National Securities Depository Limited (SEBI Registration No. IN-DP-NSDL-567-2021) having registered office at Altimus, Level 39 & 40, Pandurang Budhkar Marg, Worli, Mumbai 400018, India; Telephone no. +91-22-61181000; Compliance Officer Details: Mr. Tejarshi Hardas, Tel. No.: +91-22-61181000 or Email: tejarshi.hardas@morganstanley.com; Grievance officer details: Mr. Tejarshi Hardas, Tel. No.: +91-22-61181000 or Email: msic-compliance@morganstanley.com. Morgan Stanley India Company Private Limited (MSICPL) may use AI tools in providing research services. All recommendations contained herein are made by the duly qualified research analysts; in Germany and the European Economic Area where required by Morgan Stanley Europe S.E., authorised and regulated by Bundesanstalt fuer Finanzdienstleistungsaufsicht (BaFin) under the reference number 149169; in the US by Morgan Stanley & Co. LLC, which accepts responsibility for its contents. Morgan Stanley & Co. International plc, authorized by the Prudential Regulation Authority and regulated by the Financial Conduct Authority and the Prudential Regulation Authority, disseminates in the UK research that it has prepared, and research which has been prepared by any of its affiliates, only to persons who (i) are investment professionals falling within Article 19(5) of the Financial Services and Markets Act 2000 (Financial Promotion) Order 2005 (as amended, the "Order"); (ii) are persons who are high net worth entities falling within Article 49(2)(a) to (d) of the Order; or (iii) are persons to whom an invitation or inducement to engage in investment activity (within the meaning of section 21 of the Financial Services and Markets Act 2000, as amended) may otherwise lawfully be communicated or caused to be communicated. RMB Morgan Stanley Proprietary Limited is a member of the JSE Limited and A2X (Pty) Ltd. RMB Morgan Stanley Proprietary Limited is a joint venture owned equally by Morgan Stanley International Holdings Inc. and RMB Investment Advisory (Proprietary) Limited, which is wholly owned by FirstRand Limited. Morgan Stanley Research is disseminated in Canada by Morgan Stanley Canada Limited and Morgan Stanley Wealth Management Canada Inc., members of the Canadian Investment Regulatory Organization (CIRO). The information in Morgan Stanley Research is being disseminated by Morgan Stanley Saudi Arabia, regulated by the Capital Market Authority in the Kingdom of Saudi Arabia, and is directed at Sophisticated investors only.

Morgan Stanley Hong Kong Securities Limited is the liquidity provider/market maker for securities of AAC Technologies Holdings, BYD Electronics, FIT Hon Teng Ltd, Hon Hai Precision, Kingboard Laminates Holdings Ltd., Lenovo, Lens Technology, Luxshare Precision Industry Co., Ltd., Sunny Optical, Xiaomi Corp, Yangtze Optical Fibre and Cable JSC Ltd, Zhongji Innolight Co Ltd, ZTE Corporation listed on the Stock Exchange of Hong Kong Limited. An updated list can be found on HKEx website: http://www.hkex.com.hk.

The information in Morgan Stanley Research is being communicated by Morgan Stanley & Co. International plc (DIFC Branch), regulated by the Dubai Financial Services Authority (the DFSA) or by Morgan Stanley & Co. International plc (ADGM Branch), regulated by the Financial Services Regulatory Authority Abu Dhabi (the FSRA), and is directed at Professional Clients only, as defined by the DFSA or the FSRA, respectively. The financial products or financial services to which this research relates will only be made available to a customer who we are satisfied meets the regulatory criteria of a Professional Client. A distribution of the different MS Research ratings or recommendations, in percentage terms for Investments in each sector covered, is available upon request from your sales representative.

The information in Morgan Stanley Research is being communicated by Morgan Stanley & Co. International plc (QFC Branch), regulated by the Qatar Financial Centre Regulatory Authority (the QFCRA), and is directed at business customers and market counterparties only and is not intended for Retail Customers as defined by the QFCRA.

As required by the Capital Markets Board of Turkey, investment information, comments and recommendations stated here, are not within the scope of investment advisory activity. Investment advisory service is provided exclusively to persons based on their risk and income preferences by the authorized firms. Comments and recommendations stated here are general in nature. These opinions may not fit to your financial status, risk and return preferences. For this reason, to make an investment decision by relying solely to this information stated here may not bring about outcomes that fit your expectations.

The trademarks and service marks contained in Morgan Stanley Research are the property of their respective owners. Third-party data providers make no warranties or representations relating to the accuracy, completeness, or timeliness of the data they provide and shall not have liability for any damages relating to such data. The Global Industry Classification Standard (GICS) was developed by and is the exclusive property of MSCI and S&P.

Morgan Stanley Research, or any portion thereof may not be reprinted, sold or redistributed without the written consent of Morgan Stanley.

Indicators and trackers referenced in Morgan Stanley Research may not be used as, or treated as, a benchmark under Regulation EU 2016/1011, or any other similar framework.

The issuers and/or fixed income products recommended or discussed in certain fixed income research reports may not be continuously followed. Accordingly, investors should regard those fixed income research reports as providing stand-alone analysis and should not expect continuing analysis or additional reports relating to such issuers and/or individual fixed income products.

Morgan Stanley may hold, from time to time, material financial and commercial interests regarding the company subject to the Research report.

Registration granted by SEBI and certification from the National Institute of Securities Markets (NISM) in no way guarantee performance of the intermediary or provide any assurance of returns to investors. Investment in securities market are subject to market risks. Read all the related documents carefully before investing.

References to any prediction market or event contract do not constitute an offer, solicitation, recommendation, or endorsement to participate in any such market or contract. Morgan Stanley Research may not be distributed or made available in any jurisdiction where such distribution would be unlawful or otherwise prohibited by applicable law.

INDUSTRY COVERAGE: Greater China Technology Hardware

COMPANY (TICKER)	RATING (AS OF)	PRICE* (10/16/2026)
Andy Meng, CFA		
AAC Technologies Holdings (2018.HK)	O (01/29/2024)	HK$35.70
Accelink Technologies Co. Ltd. (002281.SZ)	U (05/12/2022)	Rmb133.75
BYD Electronics (0285.HK)	O (04/28/2023)	HK$22.04

China TransInfo Technology Co Ltd (002373.SZ)	E (07/18/2023)	Rmb7.16
Dahua Technology Co. Ltd. (002236.SZ)	E (12/12/2024)	Rmb14.69
Eoptolink Technology Inc Ltd (300502.SZ)	O (02/27/2026)	Rmb306.91
Genius Electronic Optical Co. Ltd. (3406.TW)	E (10/13/2026)	NT$1,085.00
GoerTek Inc (002241.SZ)	E (08/14/2026)	Rmb19.93
Gosuncn Technology Group Co Ltd (300098.SZ)	U (11/07/2022)	Rmb3.98
HIKVision Digital Technology (002415.SZ)	E (12/12/2024)	Rmb33.66
Largan Precision (3008.TW)	O (10/13/2026)	NT$6,400.00
LianChuang Electronic Technology Co Ltd (002036.SZ)	U (06/12/2024)	Rmb5.51
Lingyi Itech Guangdong Co (002600.SZ)	U (04/23/2025)	Rmb10.01
Lingyi Itech Guangdong Co (1688.HK)	O (08/14/2026)	HK$4.73
Luxshare Precision Industry Co., Ltd. (2475.HK)	O (08/14/2026)	HK$46.70
Luxshare Precision Industry Co., Ltd. (002475.SZ)	O (10/24/2016)	Rmb44.67
OFILM Group Co Ltd (002456.SZ)	U (06/12/2024)	Rmb6.07
Q Technology (Group) Company Ltd (1478.HK)	U (03/23/2026)	HK$4.70
Quectel Wireless Solutions Co Ltd (603236.SS)	E (10/09/2024)	Rmb66.86
Shanghai Conant Optical Co Ltd (2276.HK)	O (04/10/2026)	HK$35.16
Shenzhen Transsion Holdings Co Ltd (688036.SS)	E (03/23/2026)	Rmb48.12
Sunny Optical (2382.HK)	E (03/23/2026)	HK$57.70
Suzhou TFC Optical Communication Co Ltd. (300394.SZ)	E (11/06/2025)	Rmb212.80
Wingtech Technology Co Ltd (600745.SS)	U (05/18/2026)	Rmb13.72
Xiaomi Corp (1810.HK)	O (04/14/2021)	HK$26.66
Yangtze Optical Fibre and Cable JSC Ltd (601869.SS)	U (10/13/2021)	Rmb331.50
Yangtze Optical Fibre and Cable JSC Ltd (6869.HK)	O (07/15/2026)	HK$124.00
Yongxin Optics Co Ltd (603297.SS)	E (11/15/2022)	Rmb91.96
Zhejiang Crystal-Optech Co Ltd (002273.SZ)	O (11/15/2022)	Rmb19.40
Zhongji Innolight Co Ltd (300308.SZ)	O (09/07/2026)	Rmb670.00
Zhongji Innolight Co Ltd (3308.HK)	O (09/07/2026)	HK$805.00
ZTE Corporation (0763.HK)	O (06/04/2026)	HK$19.47
ZTE Corporation (000063.SZ)	E (06/04/2026)	Rmb27.10
Derrick Yang		
Accton Technology Corporation (2345.TW)	O (06/06/2024)	NT$1,980.00
Advantech (2395.TW)	O (01/20/2021)	NT$685.00
AirTAC International (1590.TW)	O (04/16/2025)	NT$1,155.00
Asia Vital Components Co. Ltd. (3017.TW)	O (07/30/2024)	NT$3,315.00
AU Optronics (2409.TW)	E (02/10/2026)	NT$35.90
Auras Technology Co Ltd (3324.TWO)	E (05/04/2023)	NT$1,425.00
Bizlink (3665.TW)	O (03/10/2025)	NT$2,015.00
BOE Technology (000725.SZ)	O (09/06/2019)	Rmb5.13
Chenbro (8210.TW)	O (07/23/2025)	NT$834.00
Chroma Ate Inc. (2360.TW)	O (10/05/2021)	NT$2,000.00
Delta Electronics Inc. (2308.TW)	O (07/13/2017)	NT$1,635.00
E Ink Holdings Inc. (8069.TWO)	E (08/10/2026)	NT$155.00
Ennostar Inc (3714.TW)	U (09/23/2022)	NT$63.40
Fositek Corp (6805.TW)	O (06/25/2025)	NT$2,250.00
Hiwin Technologies Corp. (2049.TW)	O (03/30/2026)	NT$311.00
Innolux (3481.TW)	E (04/07/2025)	NT$48.25
King Slide Works Co. Ltd. (2059.TW)	O (11/08/2023)	NT$9,955.00
Lens Technology (300433.SZ)	E (07/22/2020)	Rmb25.26
Lite-On Technology (2301.TW)	E (01/15/2025)	NT$264.50
TCL Corp. (000100.SZ)	E (04/07/2025)	Rmb4.54
Tianma Microelectronics (000050.SZ)	U (01/24/2018)	Rmb5.84
Howard Kao		
Acer Inc. (2353.TW)	U (04/23/2025)	NT$32.25
Asustek Computer Inc. (2357.TW)	U (11/16/2025)	NT$994.00

Catcher Technology (2474.TW)	U (11/17/2025)	NT$196.00
Compal Electronics (2324.TW)	U (04/23/2025)	NT$36.70
Elite Material Co. (2383.TW)	O (09/14/2026)	NT$5,165.00
FIT Hon Teng Ltd (6088.HK)	O (11/03/2025)	HK$4.06
Foxconn Industrial Internet Co. Ltd. (601138.SS)	O (07/10/2019)	Rmb47.78
Giga-Byte Technology Co. Ltd. (2376.TW)	E (11/16/2025)	NT$357.50
Gold Circuit Electronics Ltd. (2368.TW)	O (10/06/2022)	NT$1,245.00
Hon Hai Precision (2317.TW)	O (03/15/2024)	NT$244.00
Inspur Electronic Information (000977.SZ)	E (08/28/2023)	Rmb56.53
Kingboard Laminates Holdings Ltd. (1888.HK)	O (09/14/2026)	HK$39.48
LandMark Optoelectronics Corporation (3081.TWO)	E (03/26/2026)	NT$2,545.00
Lenovo (0992.HK)	O (07/10/2026)	HK$28.06
Lotes Co. Ltd. (3533.TW)	E (05/12/2025)	NT$1,805.00
Nan Ya PCB (8046.TW)	O (02/23/2026)	NT$1,355.00
Pegatron Corporation (4938.TW)	E (03/25/2026)	NT$102.00
Quanta Computer Inc. (2382.TW)	O (05/01/2023)	NT$322.00
Shengyi Technology Co Ltd. (600183.SS)	E (05/26/2022)	Rmb114.60
Shennan Circuits Co Ltd (002916.SZ)	E (08/24/2023)	Rmb309.99
Unimicron (3037.TW)	O (02/23/2026)	NT$1,090.00
Visual Photonics Epitaxy Co Ltd (2455.TW)	E (09/11/2023)	NT$493.00
Wistron Corporation (3231.TW)	O (07/12/2023)	NT$182.50
Wiwynn Corp (6669.TW)	O (11/10/2025)	NT$1,845.00
Yageo Corp. (2327.TW)	O (10/28/2025)	NT$567.00
Zhen Ding (4958.TW)	++	NT$557.00
Irene Yen		
Co-Tech Development Corp. (8358.TWO)	O (09/14/2026)	NT$472.00
Taiwan Union Technology Corporation (6274.TWO)	O (09/14/2026)	NT$1,615.00

Stock Ratings are subject to change. Please see latest research for each company.
* Historical prices are not split adjusted.

© 2026 Morgan Stanley